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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	12MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	26
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	2.4V ~ 3.6V
Data Converters	A/D 8x8b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-LCC (J-Lead)
Supplier Device Package	28-PLCC (11.48x11.48)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/p89lpc935fa-129

2.2 Additional features

- A high performance 80C51 CPU provides instruction cycle times of 111 ns to 222 ns for all instructions except multiply and divide when executing at 18 MHz. This is six times the performance of the standard 80C51 running at the same clock frequency. A lower clock frequency for the same performance results in power savings and reduced EMI.
- Serial flash In-Circuit Programming (ICP) allows simple production coding with commercial EPROM programmers. Flash security bits prevent reading of sensitive application programs.
- Serial flash In-System Programming (ISP) allows coding while the device is mounted in the end application.
- In-Application Programming (IAP) of the flash code memory. This allows changing the code in a running application.
- Watchdog timer with separate on-chip oscillator, requiring no external components. The watchdog prescaler is selectable from eight values.
- Low voltage reset (brownout detect) allows a graceful system shutdown when power fails. May optionally be configured as an interrupt.
- Idle and two different power-down reduced power modes. Improved wake-up from Power-down mode (a LOW interrupt input starts execution). Typical power-down current is 1 μA (total power-down with voltage comparators disabled).
- Active-LOW reset. On-chip power-on reset allows operation without external reset components. A reset counter and reset glitch suppression circuitry prevent spurious and incomplete resets. A software reset function is also available.
- Configurable on-chip oscillator with frequency range options selected by user programmed flash configuration bits. Oscillator options support frequencies from 20 kHz to the maximum operating frequency of 18 MHz.
- Oscillator fail detect. The watchdog timer has a separate fully on-chip oscillator allowing it to perform an oscillator fail detect function.
- Programmable port output configuration options: quasi-bidirectional, open drain, push-pull, input-only.
- Port ‘input pattern match’ detect. Port 0 may generate an interrupt when the value of the pins match or do not match a programmable pattern.
- LED drive capability (20 mA) on all port pins. A maximum limit is specified for the entire chip.
- Controlled slew rate port outputs to reduce EMI. Outputs have approximately 10 ns minimum ramp times.
- Only power and ground connections are required to operate the P89LPC933/934/935/936 when internal reset option is selected.
- Four interrupt priority levels.
- Eight keypad interrupt inputs, plus two additional external interrupt inputs.
- Schmitt trigger port inputs.
- Second data pointer.
- Emulation support.

3. Product comparison overview

Table 1 highlights the differences between the four devices. For a complete list of device features please see Section 2 “Features and benefits”.

Table 1. Product comparison overview

Device	Flash memory	Sector size	ADC1	ADC0	CCU	Data EEPROM
P89LPC933	4 kB	1 kB	X	-	-	-
P89LPC934	8 kB	1 kB	X	-	-	-
P89LPC935	8 kB	1 kB	X	X	X	X
P89LPC936	16 kB	2 kB	X	X	X	X

4. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
P89LPC935FA	PLCC28	plastic leaded chip carrier; 28 leads	SOT261-2
P89LPC933HDH	TSSOP28	plastic thin shrink small outline package; 28 leads; body width 4.4 mm	SOT361-1
P89LPC933FDH			
P89LPC934FDH			
P89LPC935FDH			
P89LPC936FDH			
P89LPC935FHN	HVQFN28	plastic thermal enhanced very thin quad flat package; no leads; 28 terminals; body 6 × 6 × 0.85 mm	SOT788-1

4.1 Ordering options

Table 3. Ordering options

Type number	Flash memory	Temperature range	Frequency
P89LPC933HDH	4 kB	−40 °C to +125 °C	0 MHz to 18 MHz
P89LPC933FDH	4 kB	−40 °C to +85 °C	
P89LPC935FA	8 kB		
P89LPC934FDH			
P89LPC935FDH			
P89LPC935FHN			
P89LPC936FDH	16 kB		

7. Logic symbols

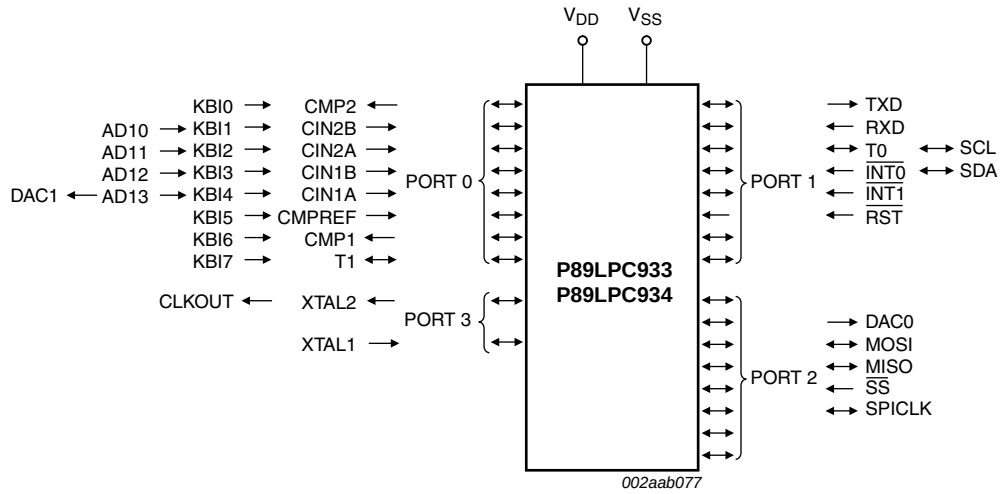


Fig 6. P89LPC933/934 logic symbol

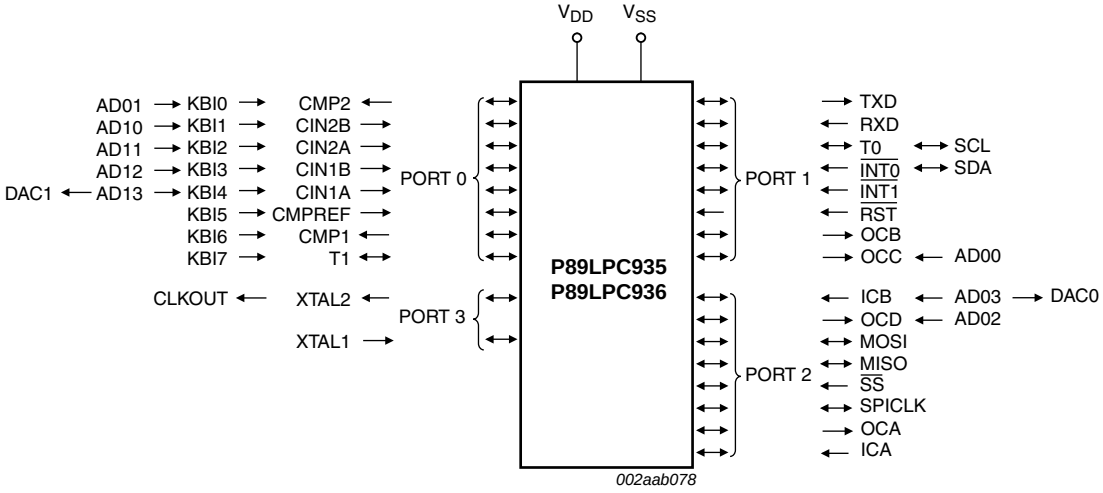


Fig 7. P89LPC935/936 logic symbol

Table 5. Special function registers - P89LPC933/934 *…continued*

** indicates SFRs that are bit addressable.*

Name	Description	SFR addr.	Bit functions and addresses		Reset value	
			MSB	LSB	Hex	Binary
WDL	Watchdog load	C1H			FF	1111 1111
WFEED1	Watchdog feed 1	C2H				
WFEED2	Watchdog feed 2	C3H				

[1] Unimplemented bits in SFRs (labeled '-') are X (unknown) at all times. Unless otherwise specified, ones should not be written to these bits since they may be used for other purposes in future derivatives. The reset values shown for these bits are logic 0s although they are unknown when read.

[2] BRGR1 and BRGR0 must only be written if BRGEN in BRGCON SFR is logic 0. If any are written while BRGEN = 1, the result is unpredictable.

[3] All ports are in input only (high-impedance) state after power-up.

[4] The RSTSRC register reflects the cause of the P89LPC933/934/935/936 reset. Upon a power-up reset, all reset source flags are cleared except POF and BOF; the power-on reset value is xx11 0000.

[5] The only reset source that affects these SFRs is power-on reset.

[6] On power-on reset, the TRIM SFR is initialized with a factory preprogrammed value. Other resets will not cause initialization of the TRIM register.

[7] After reset, the value is 1110 01x1, i.e., PRE2 to PRE0 are all logic 1, WDRUN = 1 and WDCLK = 1. WDTOF bit is logic 1 after watchdog reset and is logic 0 after power-on reset. Other resets will not affect WDTOF.

Table 6. Special function registers - P89LPC935/936

** indicates SFRs that are bit addressable.*

Name	Description	SFR addr.	Bit functions and addresses								Reset value	
			MSB							LSB	Hex	Binary
	Bit address		**E7**	**E6**	**E5**	**E4**	**E3**	**E2**	**E1**	**E0**		
ACC*	Accumulator	E0H									00	0000 0000
ADCON0	A/D control register 0	8EH	ENBI0	ENADCI 0	TMM0	EDGE0	ADCI0	ENADC0	ADCS01	ADCS00	00	0000 0000
ADCON1	A/D control register 1	97H	ENBI1	ENADCI 1	TMM1	EDGE1	ADCI1	ENADC1	ADCS11	ADCS10	00	0000 0000
ADINS	A/D input select	A3H	ADI13	ADI12	ADI11	ADI10	ADI03	ADI02	ADI01	ADI00	00	0000 0000
ADMODA	A/D mode register A	C0H	BNDI1	BURST1	SCC1	SCAN1	BNDI0	BURST0	SCC0	SCAN0	00	0000 0000
ADMODB	A/D mode register B	A1H	CLK2	CLK1	CLK0	-	ENDAC1	ENDAC0	BSA1	BSA0	00	000x 0000
AD0BH	A/D_0 boundary high register	BBH									FF	1111 1111
AD0BL	A/D_0 boundary low register	A6H									00	0000 0000
AD0DAT0	A/D_0 data register 0	C5H									00	0000 0000
AD0DAT1	A/D_0 data register 1	C6H									00	0000 0000
AD0DAT2	A/D_0 data register 2	C7H									00	0000 0000
AD0DAT3	A/D_0 data register 3	F4H									00	0000 0000
AD1BH	A/D_1 boundary high register	C4H									FF	1111 1111
AD1BL	A/D_1 boundary low register	BCH									00	0000 0000
AD1DAT0	A/D_1 data register 0	D5H									00	0000 0000
AD1DAT1	A/D_1 data register 1	D6H									00	0000 0000
AD1DAT2	A/D_1 data register 2	D7H									00	0000 0000
AD1DAT3	A/D_1 data register 3	F5H									00	0000 0000
AUXR1	Auxiliary function register	A2H	CLKLP	EBRR	ENT1	ENT0	SRST	0	-	DPS	00	0000 00x0
	Bit address		**F7**	**F6**	**F5**	**F4**	**F3**	**F2**	**F1**	**F0**		
B*	B register	F0H									00	0000 0000
BRGR0[2]	Baud rate generator rate low	BEH									00	0000 0000
BRGR1[2]	Baud rate generator rate high	BFH									00	0000 0000
BRGCON	Baud rate generator control	BDH	-	-	-	-	-	-	SBRGS	BRGEN	00[2]	xxxx xx00
CCCRA	Capture compare A control register	EAH	ICECA2	ICECA1	ICECA0	ICESA	ICNFA	FCOA	OCMA1	OCMA0	00	0000 0000

Table 6. Special function registers - P89LPC935/936 *…continued*

** indicates SFRs that are bit addressable.*

Name	Description	SFR addr.	Bit functions and addresses								Reset value	
			MSB							LSB	Hex	Binary
RSTSRC	Reset source register	DFH	-	-	BOF	POF	R_BK	R_WD	R_SF	R_EX		[4]
RTCCON	Real-time clock control	D1H	RTCF	RTCS1	RTCS0	-	-	-	ERTC	RTCEN	60[3][5]	011x xx00
RTCH	Real-time clock register high	D2H									00[5]	0000 0000
RTCL	Real-time clock register low	D3H									00[5]	0000 0000
SADDR	Serial port address register	A9H									00	0000 0000
SADEN	Serial port address enable	B9H									00	0000 0000
SBUF	Serial Port data buffer register	99H									xx	xxxx xxxx
	Bit address		**9F**	**9E**	**9D**	**9C**	**9B**	**9A**	**99**	**98**		
SCON*	Serial port control	98H	SM0/FE	SM1	SM2	REN	TB8	RB8	TI	RI	00	0000 0000
SSTAT	Serial port extended status register	BAH	DBMOD	INTLO	CIDIS	DBISEL	FE	BR	OE	STINT	00	0000 0000
SP	Stack pointer	81H									07	0000 0111
SPCTL	SPI control register	E2H	SSIG	SPEN	DORD	MSTR	CPOL	CPHA	SPR1	SPR0	04	0000 0100
SPSTAT	SPI status register	E1H	SPIF	WCOL	-	-	-	-	-	-	00	00xx xxxx
SPDAT	SPI data register	E3H									00	0000 0000
TAMOD	Timer 0 and 1 auxiliary mode	8FH	-	-	-	T1M2	-	-	-	T0M2	00	xxx0 xxx0
	Bit address		**8F**	**8E**	**8D**	**8C**	**8B**	**8A**	**89**	**88**		
TCON*	Timer 0 and 1 control	88H	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0	00	0000 0000
TCR20*	CCU control register 0	C8H	PLEEN	HLTRN	HLTEN	ALTCD	ALTAB	TDIR2	TMOD21	TMOD20	00	0000 0000
TCR21	CCU control register 1	F9H	TCOU2	-	-	-	PLLDV.3	PLLDV.2	PLLDV.1	PLLDV.0	00	0xxx 0000
TH0	Timer 0 high	8CH									00	0000 0000
TH1	Timer 1 high	8DH									00	0000 0000
TH2	CCU timer high	CDH									00	0000 0000
TICR2	CCU interrupt control register	C9H	TOIE2	TOCIE2D	TOCIE2C	TOCIE2B	TOCIE2A	-	TICIE2B	TICIE2A	00	0000 0x00
TIFR2	CCU interrupt flag register	E9H	TOIF2	TOCF2D	TOCF2C	TOCF2B	TOCF2A	-	TICF2B	TICF2A	00	0000 0x00
TISE2	CCU interrupt status encode register	DEH	-	-	-	-	-	ENCINT.2	ENCINT.1	ENCINT.0	00	xxxx x000
TL0	Timer 0 low	8AH									00	0000 0000
TL1	Timer 1 low	8BH									00	0000 0000

external clock input on X1) and if the RTC is not using the crystal oscillator as its clock source. This allows external devices to synchronize to the P89LPC933/934/935/936. This output is enabled by the ENCLK bit in the TRIM register.

The frequency of this clock output is $\frac{1}{2}$ that of the CCLK. If the clock output is not needed in Idle mode, it may be turned off prior to entering Idle, saving additional power.

8.4 On-chip RC oscillator option

The P89LPC933/934/935/936 has a 6-bit TRIM register that can be used to tune the frequency of the RC oscillator. During reset, the TRIM value is initialized to a factory preprogrammed value to adjust the oscillator frequency to 7.373 MHz $\pm$ 1 % at room temperature. End-user applications can write to the TRIM register to adjust the on-chip RC oscillator to other frequencies.

8.5 Watchdog oscillator option

The watchdog has a separate oscillator which has a frequency of 400 kHz. This oscillator can be used to save power when a high clock frequency is not needed.

8.6 External clock input option

In this configuration, the processor clock is derived from an external source driving the P3.1/XTAL1 pin. The rate may be from 0 Hz up to 18 MHz. The P3.0/XTAL2 pin may be used as a standard port pin or a clock output. **When using an oscillator frequency above 12 MHz, the reset input function of P1.5 must be enabled. An external circuit is required to hold the device in reset at power-up until VDD has reached its specified level. When system power is removed VDD will fall below the minimum specified operating voltage. When using an oscillator frequency above 12 MHz, in some applications, an external brownout detect circuit may be required to hold the device in reset when VDD falls below the minimum specified operating voltage.**

8.13 I/O ports

The P89LPC933/934/935/936 has four I/O ports: Port 0, Port 1, Port 2, and Port 3. Ports 0, 1 and 2 are 8-bit ports, and Port 3 is a 2-bit port. The exact number of I/O pins available depends upon the clock and reset options chosen, as shown in Table 8.

Table 8. Number of I/O pins available

Clock source	Reset option	Number of I/O pins (28-pin package)
On-chip oscillator or watchdog oscillator	No external reset (except during power-up)	26
	External $\overline{\text{RST}}$ pin supported	25
External clock input	No external reset (except during power-up)	25
	External $\overline{\text{RST}}$ pin supported[1]	24
Low/medium/high speed oscillator (external crystal or resonator)	No external reset (except during power-up)	24
	External $\overline{\text{RST}}$ pin supported[1]	23

[1] Required for operation above 12 MHz.

8.13.1 Port configurations

All but three I/O port pins on the P89LPC933/934/935/936 may be configured by software to one of four types on a bit-by-bit basis. These are: quasi-bidirectional (standard 80C51 port outputs), push-pull, open drain, and input-only. Two configuration registers for each port select the output type for each port pin.

1. P1.5 ($\overline{\text{RST}}$) can only be an input and cannot be configured.
2. P1.2 (SCL/T0) and P1.3 (SDA/$\overline{\text{INT0}}$) may only be configured to be either input-only or open-drain.

8.13.1.1 Quasi-bidirectional output configuration

Quasi-bidirectional output type can be used as both an input and output without the need to reconfigure the port. This is possible because when the port outputs a logic HIGH, it is weakly driven, allowing an external device to pull the pin LOW. When the pin is driven LOW, it is driven strongly and able to sink a fairly large current. These features are somewhat similar to an open-drain output except that there are three pull-up transistors in the quasi-bidirectional output that serve different purposes.

The P89LPC933/934/935/936 is a 3 V device, but the pins are 5 V-tolerant. In quasi-bidirectional mode, if a user applies 5 V on the pin, there will be a current flowing from the pin to V_{DD}, causing extra power consumption. Therefore, applying 5 V in quasi-bidirectional mode is discouraged.

A quasi-bidirectional port pin has a Schmitt trigger input that also has a glitch suppression circuit.

8.13.1.2 Open-drain output configuration

The open-drain output configuration turns off all pull-ups and only drives the pull-down transistor of the port driver when the port latch contains a logic 0. To be used as a logic output, a port configured in this manner must have an external pull-up, typically a resistor tied to V_{DD}.

An open-drain port pin has a Schmitt trigger input that also has a glitch suppression circuit.

8.13.1.3 Input-only configuration

The input-only port configuration has no output drivers. It is a Schmitt trigger input that also has a glitch suppression circuit.

8.13.1.4 Push-pull output configuration

The push-pull output configuration has the same pull-down structure as both the open-drain and the quasi-bidirectional output modes, but provides a continuous strong pull-up when the port latch contains a logic 1. The push-pull mode may be used when more source current is needed from a port output. A push-pull port pin has a Schmitt trigger input that also has a glitch suppression circuit.

8.13.2 Port 0 analog functions

The P89LPC933/934/935/936 incorporates two Analog Comparators. In order to give the best analog function performance and to minimize power consumption, pins that are being used for analog functions must have the digital outputs and digital inputs disabled.

Digital outputs are disabled by putting the port output into the Input-Only (high-impedance) mode.

Digital inputs on Port 0 may be disabled through the use of the PT0AD register, bits 1:5. On any reset, PT0AD[1:5] defaults to logic 0s to enable digital functions.

8.13.3 Additional port features

After power-up, all pins are in Input-Only mode.

Remark: Please note that this is different from the LPC76x series of devices.

- After power-up, all I/O pins except P1.5, may be configured by software.
- Pin P1.5 is input only. Pins P1.2 and P1.3 and are configurable for either input-only or open-drain.

Every output on the P89LPC933/934/935/936 has been designed to sink typical LED drive current. However, there is a maximum total output current for all ports which must not be exceeded. Please refer to Table 11 “Static characteristics” for detailed specifications.

All ports pins that can function as an output have slew rate controlled outputs to limit noise generated by quickly switching output signals. The slew rate is factory-set to approximately 10 ns rise and fall times.

8.14 Power monitoring functions

The P89LPC933/934/935/936 incorporates power monitoring functions designed to prevent incorrect operation during initial power-up and power loss or reduction during operation. This is accomplished with two hardware functions: Power-on detect and brownout detect.

Capture Noise Filter bit. If set, the capture logic needs to see four consecutive samples of the same value in order to recognize an edge as a capture event. An event counter can be set to delay a capture by a number of capture events.

8.19.6 PWM operation

PWM operation has two main modes, symmetrical and asymmetrical.

In asymmetrical PWM operation the CCU timer operates in down-counting mode regardless of the direction control bit.

In symmetrical mode, the timer counts up/down alternately. The main difference from basic timer operation is the operation of the compare module, which in PWM mode is used for PWM waveform generation.

As with basic timer operation, when the PWM (compare) pins are connected to the compare logic, their logic state remains unchanged. However, since bit FCO is used to hold the halt value, only a compare event can change the state of the pin.

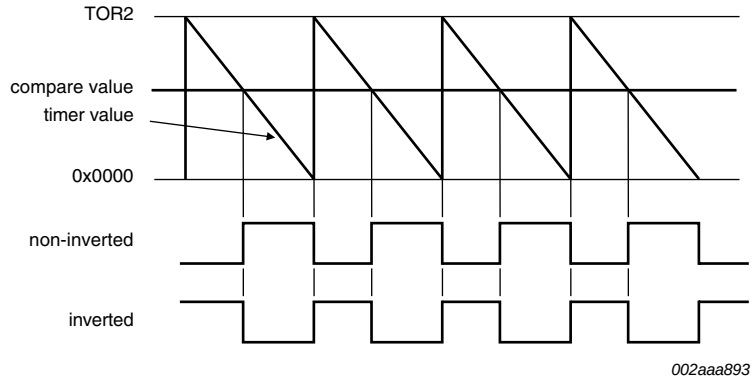


Fig 10. Asymmetrical PWM, down-counting mode

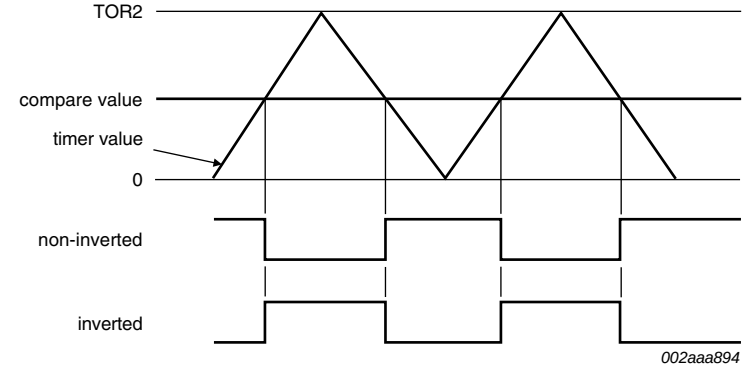


Fig 11. Symmetrical PWM

8.21 I²C-bus serial interface

The I²C-bus uses two wires (SDA and SCL) to transfer information between devices connected to the bus, and it has the following features:

- Bidirectional data transfer between masters and slaves
- Multi master bus (no central master)
- Arbitration between simultaneously transmitting masters without corruption of serial data on the bus
- Serial clock synchronization allows devices with different bit rates to communicate via one serial bus
- Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer
- The I²C-bus may be used for test and diagnostic purposes.

A typical I²C-bus configuration is shown in Figure 15. The P89LPC933/934/935/936 device provides a byte-oriented I²C-bus interface that supports data transfers up to 400 kHz.

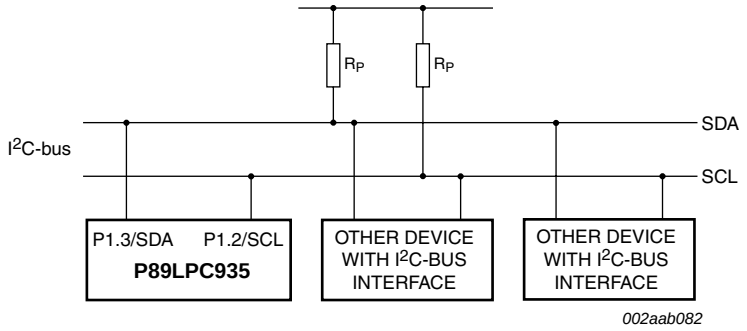


Fig 15. I²C-bus configuration

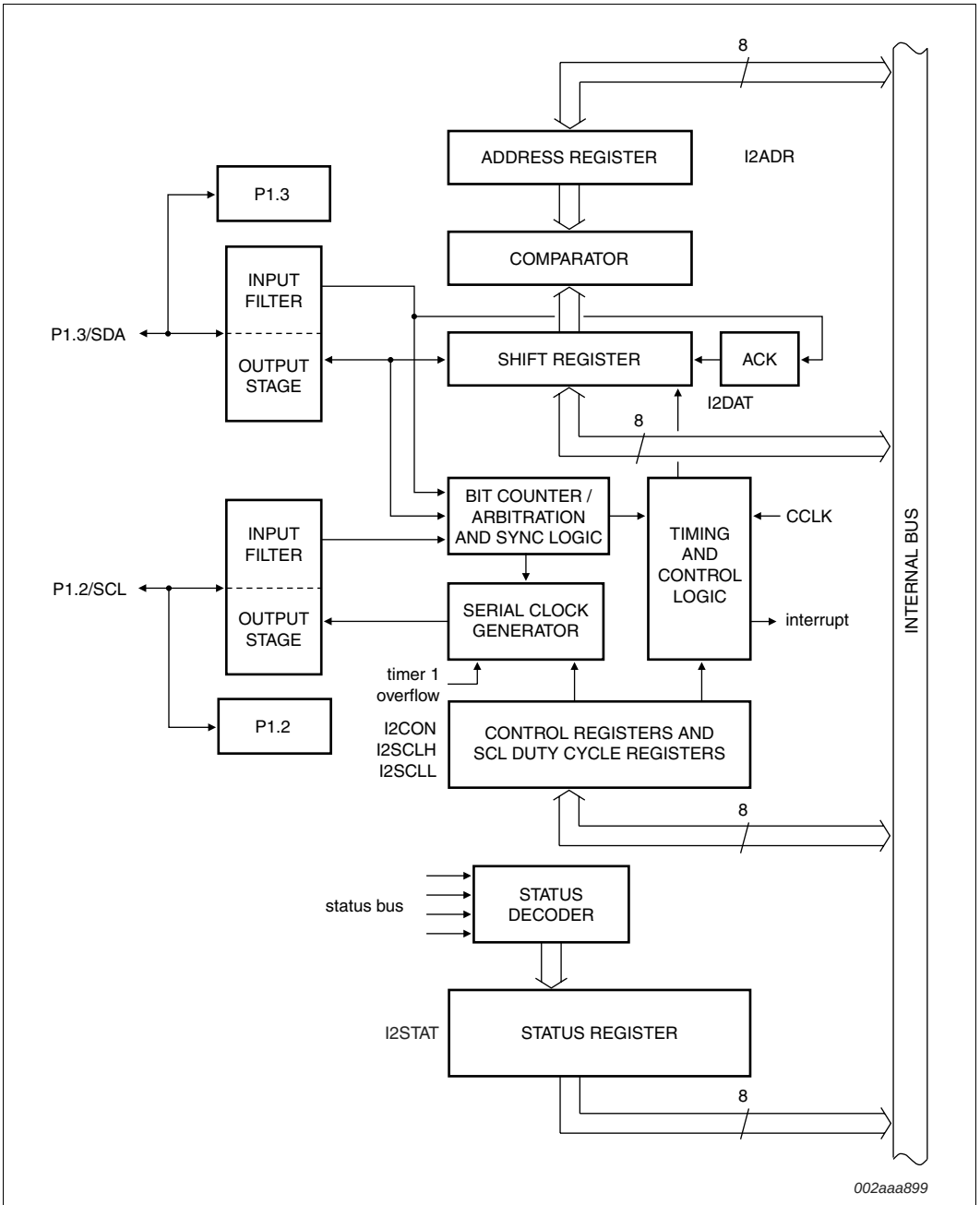
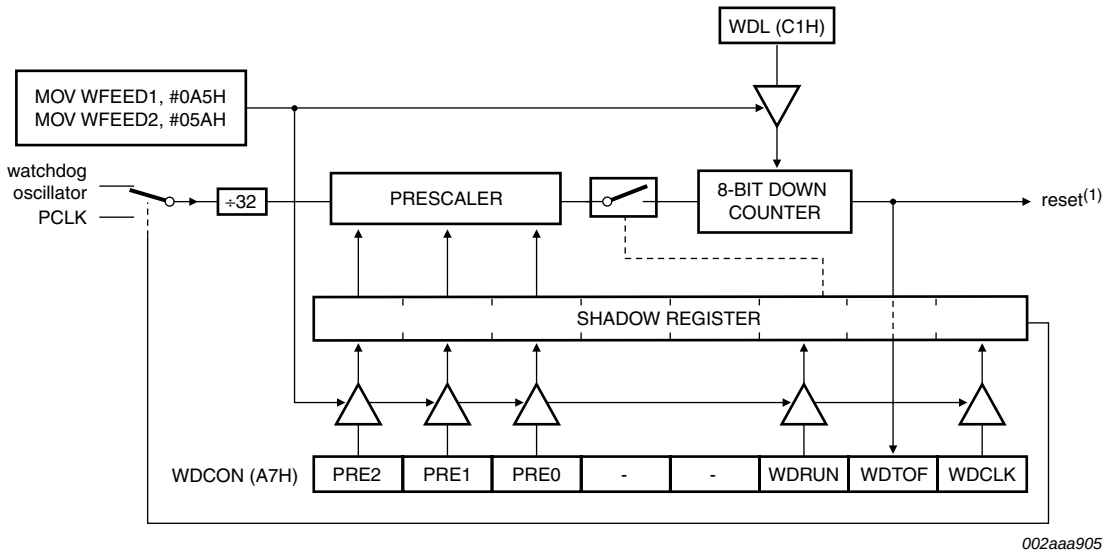


Fig 16. I²C-bus serial interface block diagram

8.25 Watchdog timer

The watchdog timer causes a system reset when it underflows as a result of a failure to feed the timer prior to the timer reaching its terminal count. It consists of a programmable 12-bit prescaler, and an 8-bit down counter. The down counter is decremented by a tap taken from the prescaler. The clock source for the prescaler is either the PCLK or the nominal 400 kHz watchdog oscillator. The watchdog timer can only be reset by a power-on reset. When the watchdog feature is disabled, it can be used as an interval timer and may generate an interrupt. Figure 22 shows the watchdog timer in Watchdog mode. Feeding the watchdog requires a two-byte sequence. If PCLK is selected as the watchdog clock and the CPU is powered-down, the watchdog is disabled. The watchdog timer has a time-out period that ranges from a few μs to a few seconds. Please refer to the P89LPC933/934/935/936 *User manual* for more details.



(1) Watchdog reset can also be caused by an invalid feed sequence, or by writing to WDCON not immediately followed by a feed sequence.

Fig 22. Watchdog timer in Watchdog mode (WDTE = 1)

8.26 Additional features

8.26.1 Software reset

The SRST bit in AUXR1 gives software the opportunity to reset the processor completely, as if an external reset or watchdog reset had occurred. Care should be taken when writing to AUXR1 to avoid accidental software resets.

8.26.2 Dual data pointers

The dual Data Pointers (DPTR) provides two different Data Pointers to specify the address used with certain instructions. The DPS bit in the AUXR1 register selects one of the two Data Pointers. Bit 2 of AUXR1 is permanently wired as a logic 0 so that the DPS bit may be toggled (thereby switching Data Pointers) simply by incrementing the AUXR1 register, without the possibility of inadvertently altering other bits in the register.

10. Limiting values

Table 10. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

Symbol	Parameter	Conditions	Min	Max	Unit
$T_{amb(bias)}$	bias ambient temperature		−55	+125	°C
T_{stg}	storage temperature		−65	+150	°C
$I_{OH(I/O)}$	HIGH-level output current per input/output pin		-	20	mA
$I_{OL(I/O)}$	LOW-level output current per input/output pin		-	20	mA
$I_{I/Otot(max)}$	maximum total input/output current		-	100	mA
V_{xtal}	crystal voltage	on XTAL1, XTAL2 pin to V_{SS}	-	V_{DD} + 0.5	V
V_n	voltage on any other pin	except XTAL1, XTAL2 to V_{SS}	−0.5	+5.5	V
$P_{tot(pack)}$	total power dissipation (per package)	based on package heat transfer, not device power consumption	-	1.5	W

[1] The following applies to Table 10:

a) This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maximum.

b) Parameters are valid over ambient temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

12. Dynamic characteristics

Table 12. Dynamic characteristics (12 MHz)

V_{DD} = 2.4 V to 3.6 V unless otherwise specified.

T_{amb} = −40 °C to +85 °C for industrial, −40 °C to +125 °C for extended, unless otherwise specified.[1][2]

Symbol	Parameter	Conditions	Variable clock		f_{osc} = 12 MHz		Unit
			Min	Max	Min	Max	
$f_{osc(RC)}$	internal RC oscillator frequency		7.189	7.557	7.189	7.557	MHz
$f_{osc(WD)}$	internal watchdog oscillator frequency		320	520	320	520	kHz
f_{osc}	oscillator frequency		0	12	-	-	MHz
$T_{cy(clk)}$	clock cycle time	see Figure 27	83	-	-	-	ns
f_{CLKLP}	low-power select clock frequency		0	8	-	-	MHz
Glitch filter							
t_{gr}	glitch rejection time	P1.5/$\overline{RST}$ pin	-	50	-	50	ns
		any pin except P1.5/$\overline{RST}$	-	15	-	15	ns
t_{sa}	signal acceptance time	P1.5/$\overline{RST}$ pin	125	-	125	-	ns
		any pin except P1.5/$\overline{RST}$	50	-	50	-	ns
External clock							
t_{CHCX}	clock HIGH time	see Figure 27	33	$T_{cy(CLK)} - t_{CLCX}$	33	-	ns
t_{CLCX}	clock LOW time	see Figure 27	33	$T_{cy(CLK)} - t_{CHCX}$	33	-	ns
t_{CLCH}	clock rise time	see Figure 27	-	8	-	8	ns
t_{CHCL}	clock fall time	see Figure 27	-	8	-	8	ns
Shift register (UART mode 0)							
T_{XLXL}	serial port clock cycle time	see Figure 25	$16T_{cy(CLK)}$	-	1333	-	ns
t_{QVXH}	output data set-up to clock rising edge time	see Figure 25	$13T_{cy(CLK)}$	-	1083	-	ns
t_{XHQX}	output data hold after clock rising edge time	see Figure 25	-	$T_{cy(CLK)}$ + 20	-	103	ns
t_{XHDX}	input data hold after clock rising edge time	see Figure 25	-	0	-	0	ns
t_{XHDV}	input data valid to clock rising edge time	see Figure 25	150	-	150	-	ns
SPI interface							
f_{SPI}	SPI operating frequency						
	slave		0	$^{CCLK}/_{6}$	0	2.0	MHz
	master		-	$^{CCLK}/_{4}$	-	3.0	MHz
T_{SPICYC}	SPI cycle time	see Figure 26, 28, 29, 30					
	slave		$^{6}/_{CCLK}$	-	500	-	ns
	master		$^{4}/_{CCLK}$	-	333	-	ns
$t_{SPILEAD}$	SPI enable lead time	see Figure 29, 30					
	slave		250	-	250	-	ns

Table 12. Dynamic characteristics (12 MHz) *…continued*

V_{DD} = 2.4 V to 3.6 V unless otherwise specified.

T_{amb} = −40 °C to +85 °C for industrial, −40 °C to +125 °C for extended, unless otherwise specified.[1][2]

Symbol	Parameter	Conditions	Variable clock		f_{osc} = 12 MHz		Unit
			Min	Max	Min	Max	
t_{SPILAG}	SPI enable lag time	see Figure 29, 30					
	slave		250	-	250	-	ns
$t_{SPICLKH}$	SPICLK HIGH time	see Figure 26, 28, 29, 30					
	master		$^{2}/_{CCLK}$	-	165	-	ns
	slave		$^{3}/_{CCLK}$	-	250	-	ns
$t_{SPICLKL}$	SPICLK LOW time	see Figure 26, 28, 29, 30					
	master		$^{2}/_{CCLK}$	-	165	-	ns
	slave		$^{3}/_{CCLK}$	-	250	-	ns
t_{SPIDSU}	SPI data set-up time	see Figure 26, 28, 29, 30					
	master or slave		100	-	100	-	ns
t_{SPIDH}	SPI data hold time	see Figure 26, 28, 29, 30					
	master or slave		100	-	100	-	ns
t_{SPIA}	SPI access time	see Figure 29, 30					
	slave		0	120	0	120	ns
t_{SPIDIS}	SPI disable time	see Figure 29, 30					
	slave		0	240	-	240	ns
t_{SPIDV}	SPI enable to output data valid time	see Figure 26, 28, 29, 30					
	slave		-	240	-	240	ns
	master		-	167	-	167	ns
t_{SPIOH}	SPI output data hold time	see Figure 26, 28, 29, 30	0	-	0	-	ns
t_{SPIR}	SPI rise time	see Figure 26, 28, 29, 30					
	SPI outputs (SPICLK, MOSI, MISO)		-	100	-	100	ns
	SPI inputs (SPICLK, MOSI, MISO, $\overline{SS}$)		-	2000	-	2000	ns
t_{SPIF}	SPI fall time	see Figure 26, 28, 29, 30					
	SPI outputs (SPICLK, MOSI, MISO)		-	100	-	100	ns
	SPI inputs (SPICLK, MOSI, MISO, $\overline{SS}$)		-	2000	-	2000	ns

[1] Parameters are valid over ambient temperature range unless otherwise specified.

[2] Parts are tested to 2 MHz, but are guaranteed to operate down to 0 Hz.

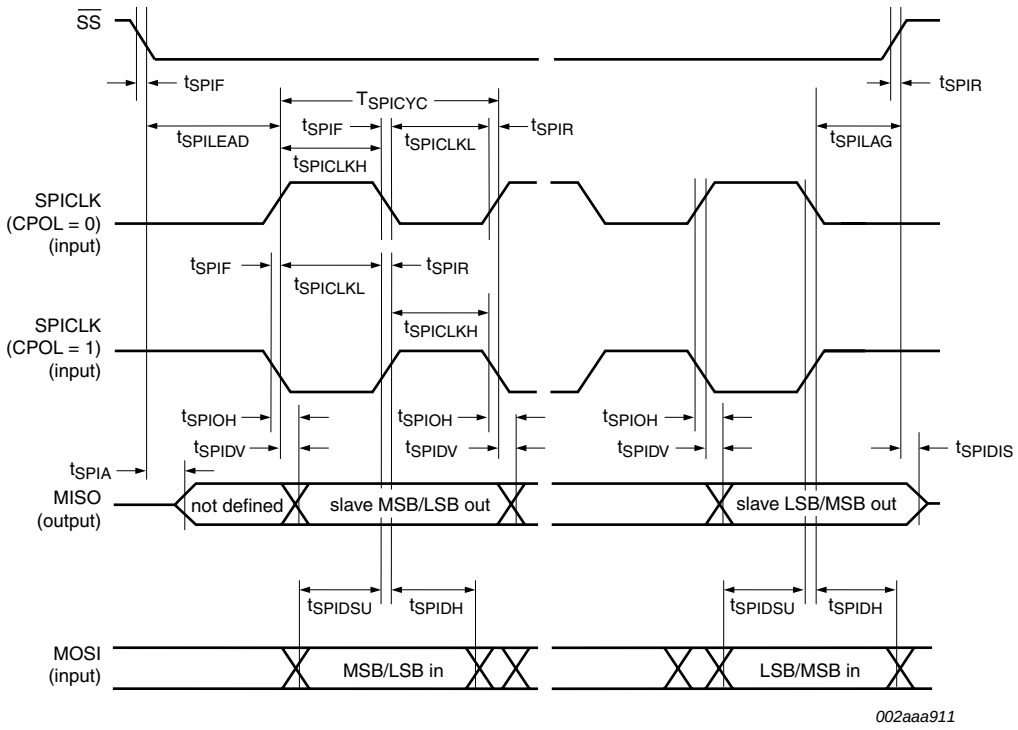


Fig 30. SPI slave timing (CPHA = 1)

12.2 ISP entry mode

Table 14. Dynamic characteristics, ISP entry mode

V_{DD} = 2.4 V to 3.6 V, unless otherwise specified.
T_{amb} = −40 °C to +85 °C for industrial, −40 °C to +125 °C for extended, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_{VR}	$\overline{RST}$ delay from V_{DD} active time		50	-	-	µs
t_{RH}	$\overline{RST}$ HIGH time		1	-	32	µs
t_{RL}	$\overline{RST}$ LOW time		1	-	-	µs

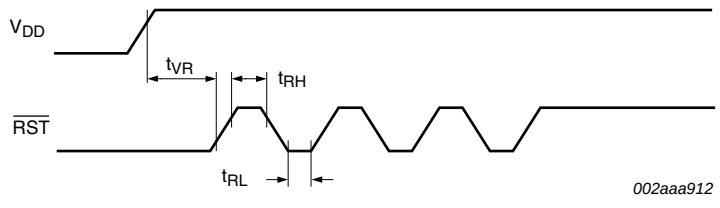


Fig 31. ISP entry timing

13.2 ADC electrical characteristics

Table 16. ADC electrical characteristics

V_{DD} = 2.4 V to 3.6 V, unless otherwise specified.
T_{amb} = −40 °C to +85 °C for industrial, −40 °C to +125 °C for extended, unless otherwise specified.
All limits valid for an external source impedance of less than 10 kΩ.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{IA}	analog input voltage		V_{SS} −0.2	-	V_{DD} +0.2	V
C_{iss}	input capacitance		-	-	15	pF
E_D	differential linearity error		-	-	±1	LSB
$E_{L(adj)}$	integral non-linearity		-	-	±1	LSB
E_O	offset error		-	-	±2	LSB
E_G	gain error		-	-	±1	%
$E_{u(tot)}$	total unadjusted error		-	-	±2	LSB
M_{CTC}	channel-to-channel matching		-	-	±1	LSB
$\alpha_{ct(port)}$	crosstalk between port inputs	0 kHz to 100 kHz	-	-	−60	dB
SR_{in}	input slew rate		-	-	100	V/ms
$T_{cy(ADC)}$	ADC clock cycle time		111	-	2000	ns
t_{ADC}	ADC conversion time	A/D enabled	-	-	$13T_{cy(ADC)}$	ns

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